

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
I-HUNG CHIANG	07/10/2020
HUNG-HSIEN KO	07/10/2020
CHENG-TA PAN	07/10/2020
YU-LIN HSU	07/10/2020
KUO-HUA TSENG	07/10/2020
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16937592
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NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	07/27/2020
Total Attachments: 3 source=096023_ASSN#page1.tif	

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ASSIGNMENT

WHEREAS,

**1.Hung Chiang
3.Cheng-Ta Pan
5.Kuo-Hua Tseng**

**2.Hung-Hsien Ko
4.Yu-Lin Hsu**

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **STRAIN MEASUREMENT METHOD AND STRAIN MEASUREMENT APPARATUS**

Filed: Serial No.

Executed concurrently with the execution of this instrument

**WHEREAS, 1. Industrial Technology Research Institute
of No. 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu
31040, Taiwan, R. O. C.**

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: I-Hung Chiang Date: 2020.7.10

Sole or First Joint Inventor: **I-Hung Chiang**

Signature: Hung-Hsien Ko Date: 2020.7.10

Second Joint Inventor (if any): **Hung-Hsien Ko**

Signature: _____ Date: _____

Third Joint Inventor (if any): **Cheng-Ta Pan**

Signature: Yu-Lin Hsu Date: 2020.7.10

Fourth Joint Inventor (if any): **Yu-Lin Hsu**

Signature: Kuo-Hua Tseng Date: 2020.7.10

Fifth Joint Inventor (if any): **Kuo-Hua Tseng**

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: _____ Date: _____

Sole or First Joint Inventor: **I-Hung Chiang**

Signature: _____ Date: _____

Second Joint Inventor (if any): **Hung-Hsien Ko**

Signature: Cheng-Ta Pan Date: 2020/07/10

Third Joint Inventor (if any): **Cheng-Ta Pan**

JUL 10 2020

Signature: _____ Date: _____

Fourth Joint Inventor (if any): **Yu-Lin Hsu**

Signature: _____ Date: _____

Fifth Joint Inventor (if any): **Kuo-Hua Tseng**